YIDONG REN

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428 S. Shaw Lane, East Lansing, MI - 48824, USA

RESEARCH INTERESTS

Internet of Things, Wireless Networking, Low-Power Wide-Area Network, Smart Agriculture

EDUCATION

Michigan State University

East Lansing, USA

Ph.D. Candidate, Department of Computer Science and Engineering

2021 - Present

Advisor: Zhichao Cao

University of Electronic Science and Technology of China

Chengdu, China

B.E., Electronic and Information Engineering

2017 - 2021

CONFERENCE PUBLICATIONS

* denotes equal contribution, _ are students I mentor

First-author papers:

INTERCONT OFF

INFOCOM 2025 [C1] AeroEcho: Towards Agricultural Low-power Wide-area Backscatter with Aerial Excitation

Source.

Yidong Ren, Gen Li, Yimeng Liu, Younsuk Dong, Zhichao Cao

IEEE Conference on Computer Communications, 2025

Acceptance ratio: 18.66%

MobiCom 2024

[C2] SateRIoT: High-performance Ground-Space Networking for Rural IoT.

Yidong Ren, Amalinda Gamage, Li Liu, Mo Li, Shigang Chen, Younsuk Dong, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking.

Acceptance ratio: 20.85%

MobiCom 2024

[C3] Demeter: Reliable Cross-soil LPWAN with Low-cost Signal Polarization Alignment.

Yidong Ren, Wei Sun, Jialuo Du, Huaili Zeng, Younsuk Dong, Mi Zhang, Shigang Chen, Yunhao

Liu, Tianxing Li, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking.

Acceptance ratio: 20.85%

MobiSys 2024

[C4] ChirpTransformer: Versatile LoRa Encoding for Low-power Wide-area IoT.

Yidong Ren* (co-primary author), Chenning Li*, Shuai Tong, Shakhrul Iman Siam, Mi Zhang,

Jiliang Wang, Yunhao Liu, Zhichao Cao.

The 22nd ACM International Conference on Mobile Systems, Applications, and Services

Acceptance ratio: 16.35%

INFOCOM 2023

[C5] Prism: High-throughput LoRa Backscatter with Non-linear Chirps.

Yidong Ren, Puyu Cai, Jinyan Jiang, Jialuo Du, Zhichao Cao.

IEEE Conference on Computer Communications, 2023

Acceptance ratio: 19.21%

ICNP 2022

[C6] Is Lorawan Really Wide? Fine-grained LoRa Link-level Measurement in An Urban Environ-

ment.

Yidong Ren* (co-primary author), Li Liu*, Chenning Li*, Zhichao Cao and Shigang Chen.

The 30th IEEE International Conference on Network Protocols.

Acceptance ratio: 21.43%

Other papers:

SenSys 2025 [C7] Proteus: Er

[C7] Proteus: Enhanced mmWave Leaf Wetness Detection with Cross-Modality Knowledge Trans-

fer

Yimeng Liu, Maolin Gan, Huaili Zeng, Yidong Ren, Gen Li, Jingkai Lin, Younsuk Dong, Xiaobo

Tan, Zhichao Cao.

The 23rd ACM Conference on Embedded Networked Sensor Systems.

Acceptance ratio: 18.78%

MobiCom 2024 [C8] LoRaTrimmer: Optimal Energy Condensation with Chirp Trimming for LoRa Weak Signal

Decoding.

Jialuo Du, Yunhao Liu, Yidong Ren, Li Liu, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking.

Acceptance ratio: 20.85%

SenSys 2024 [C9] PiezoBud: A Piezo-Aided Secure Earbud with Practical Speaker Authentication.

Gen Li*, Huaili Zeng*, Hanqing Guo, Yidong Ren, Aiden Dixon, Zhichao Cao and Tianxing Li.

The 22nd ACM Conference on Embedded Networked Sensor Systems.

Acceptance ratio: 18.53%

MobiHoc 2023 [C10] SRLoRa: Neural-enhanced LoRa Weak Signal Decoding with Multi-gateway Super Resolu-

ion.

Jialuo Du, Yidong Ren, Zhuizhu, Chenning Li, Zhichao Cao, Qiang Ma, Yunhao Liu.

The 24th International Symposium on Theory, Algorithmic Foundations, and Protocol Design for

Mobile Networks and Mobile Computing

Acceptance ratio: 22.06%

JOURNAL PUBLICATIONS

TMC [J1] Morph: ChirpTransformer-based Encoder-decoder Co-design for Reliable LoRa Communication.

Yidong Ren, Maolin Gan, Mi Zhang, Shigang Chen, Zhichao Cao.

Under review of IEEE Transactions on Mobile Computing

TIoT [J2] NELoRa: Towards Ultra-low SNR LoRa Communication with Neural-enhanced Demodulation.

Maolin Gan*, Khang Nguyen*, Jialuo Du, Yidong Ren, Huacheng Zeng, Mi Zhang, Shigang Chen,

Zhichao Cao.

Under review of ACM Transactions on Internet of Things

TMC [J3] Channel Adapted Antenna Augmentation for Improved Wi-Fi Throughput.

Yanbo Zhang, Weiping Sun, Yidong Ren, Sung-ju Lee, Mo Li.

IEEE Transactions on Mobile Computing, 2022.

BENCKMARK

ICLR ML4IoT NELoRa-Bench: A Benchmark for Neural-enhanced LoRa Demodulation.

Jialuo Du, Yidong Ren, Mi Zhang, Yunhao Liu and Zhichao Cao.

International Conference on Learning Representations Workshop on Machine Learning for IoT,

2023. Oral

DEMO

MobiCom 2024 Demeter-Demo: Demonstrating Cross-soil LPWAN with Low-cost Signal Polarization Alignment.

Yidong Ren, Yawen Wang, Younsuk Dong, Shigang Chen, Mi Zhang, Jiliang Tang, Zhichao Cao. The 30th Annual International Conference On Mobile Computing And Networking (**Demo**)

INTERNSHIP EXPERIENCE

Qualcomm, WLAN System Team. Santa Clara, CA, USA

06/2024 - 09/2024

Research on DNN-assisted Wi-Fi CSI localization and Deep reinforcement learning for Wi-Fi roaming.

TEACHING EXPERIENCE

Michigan State University, Department of Computer Science and Engineering

Teaching Assistant

• CSE 220 — Programming in C

Spring 2022, Spring 2023, Spring 2024

ACADEMIC SERVICE

Programm Committee of

• USENIX Security Artifact Evaluation

2025

ACM MobiCom Artifact Evaluation

2024-2025

ACM MobiSys Artifact Evaluation

2024

• ACM SenSys Artifact Evaluation

2024

• IEEE International Conference on Parallel and Distributed Systems (ICPADS)

2024

Invited Journal Reviewer of

IEEE/ACM Transactions on Networking	2023-2025
IEEE Transactions on Mobile Computing	2024-2025
IEEE Transactions on Communication	2025
IEEE Transactions on Wireless Communication	2025
IEEE Internet Computing	2025
ACM Transactions on Sensor Network	2022-2024
Conference Reviewer of	
IEEE International Symposium on Dynamic Spectrum Access Networks (DySpan)	2022-2023
• EAI MobiQuitous	2022
MENTORSHIP	
Puyu Cai	02/2022-12/2022
Now: Master student at Computer Science Department, New York University	
Khang Nguyen, Nam Nguyen	03/2023 - Present
Now: Honor College, Michigan State University	
HONOR AND AWARDS	
Dissertation Completion Fellowship, Graduate School at Michigan State University	2025
Distinguished Artifact Reviewer, ACM MobiCom	2024
Student Travel Grant, ACM MobiCom	2024 2024
Student Travel Grant, ACM MobiSys Student Travel Grant, ACM MobiHoc	2024
Student Travel Grant, IEEE ICNP	2022

GRANTS EXPERIENCE

I assisted in the preparation of proposals for the following research grants:

NSF: LoRa Enabled Space-air-ground Integrated Networks for Next-Generation Agricultural IoT. Award number 2338976.

NSF: Towards High-Performing LoRa with Embedded Intelligence on the Edge. Award number 2312674.